



**Joint ITU-T/IEEE Workshop  
on The Future of Ethernet Transport**



**(Geneva, 28 May 2010)**

**Technologies & Architectures for Next  
Gen Ethernet Optical Client Interfaces**

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Opnext**

Geneva, 28 May 2010

- Where have we been
- Where are we at
- Where are we going
  
- Acknowledgement
  - The following from Opnext and Hitachi CRL contributed to this presentation:
    - K. Hiramoto
    - M. Okayasu
    - T. Sugawara
    - M. Traverso

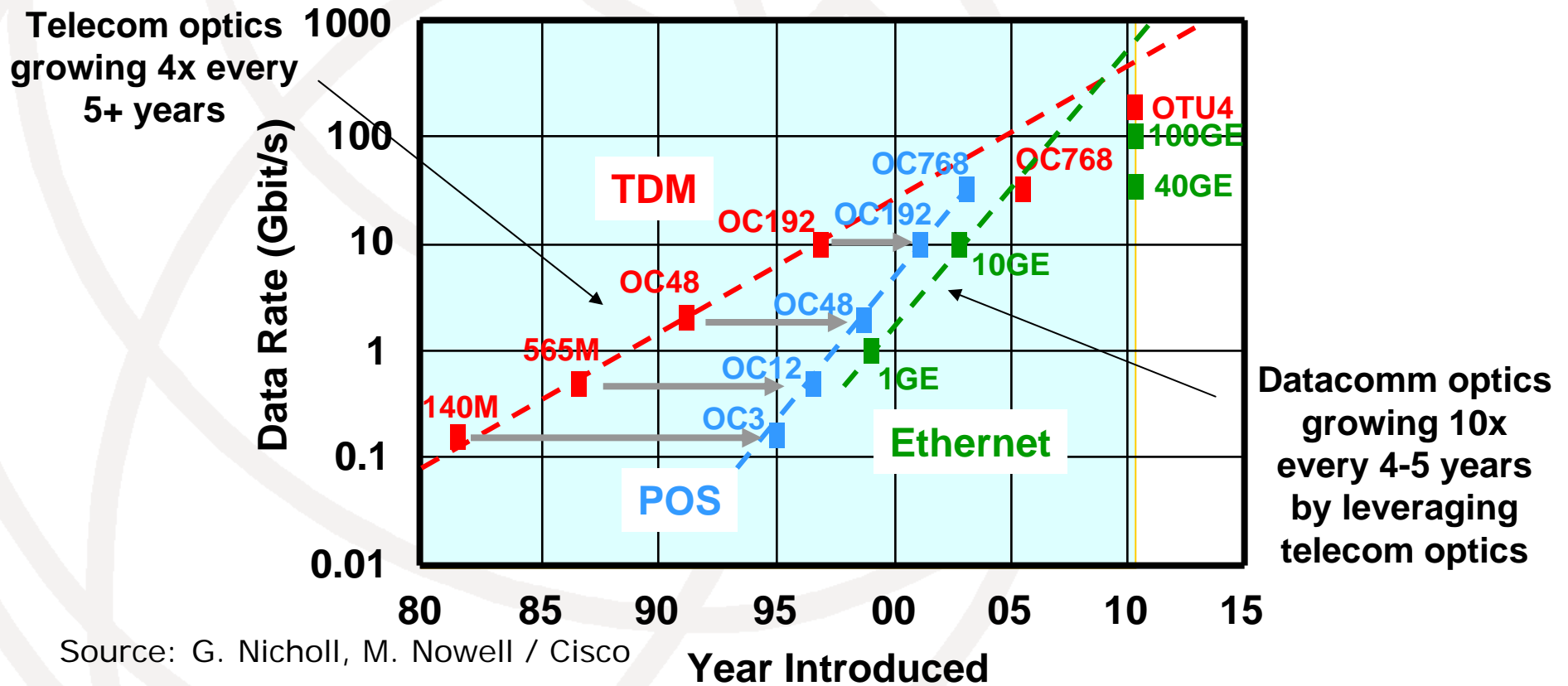


# IEEE Client Optical Interface Evolution



- In the past, Datacomm industry has leveraged Telecom optical technology
- We are now in a cross-over period.

Network and Router I/F Speeds (Gbit/s)

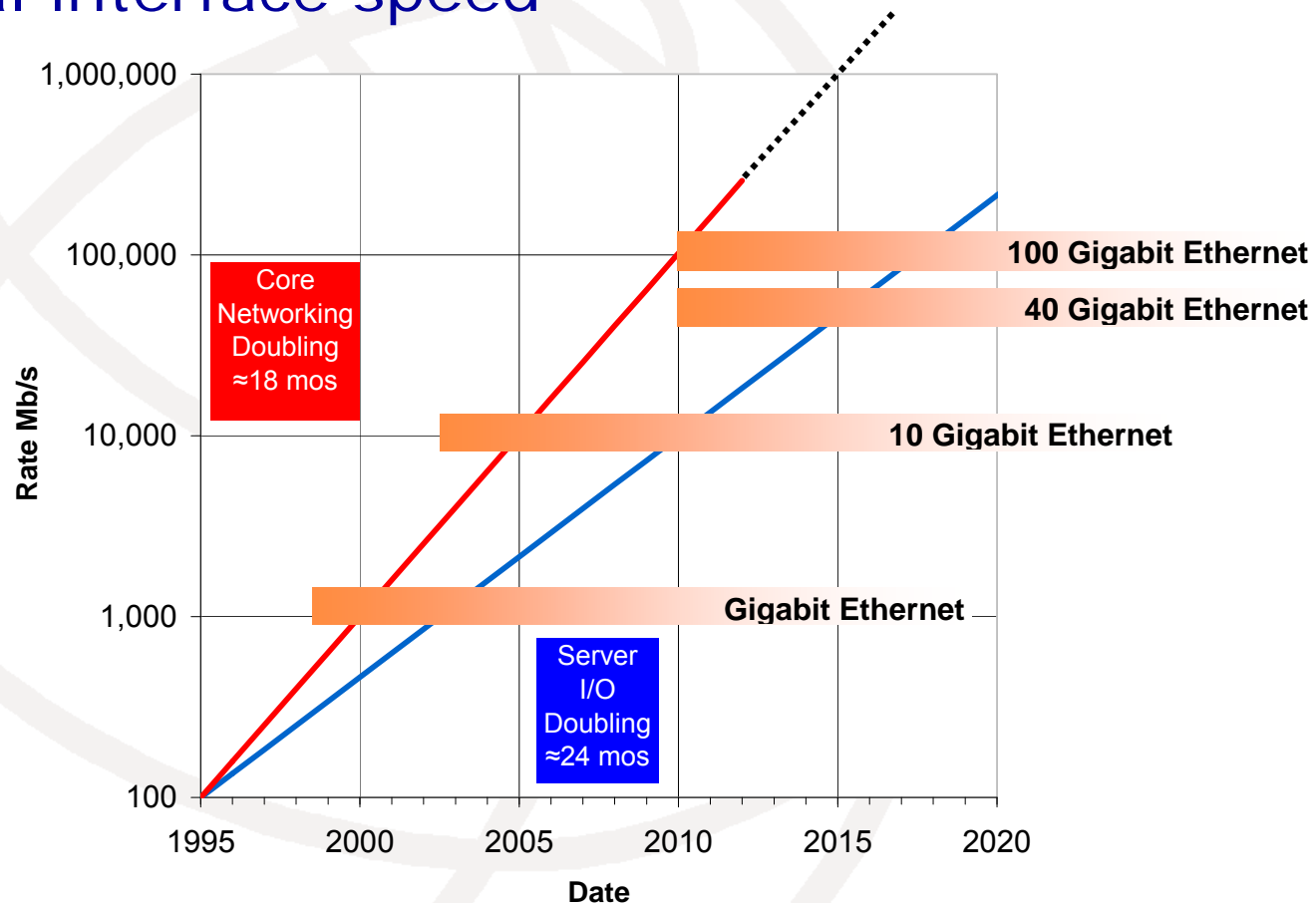




# Computing & Networking Bandwidth Growth



- Core networking bandwidth demand is outpacing optical interface speed



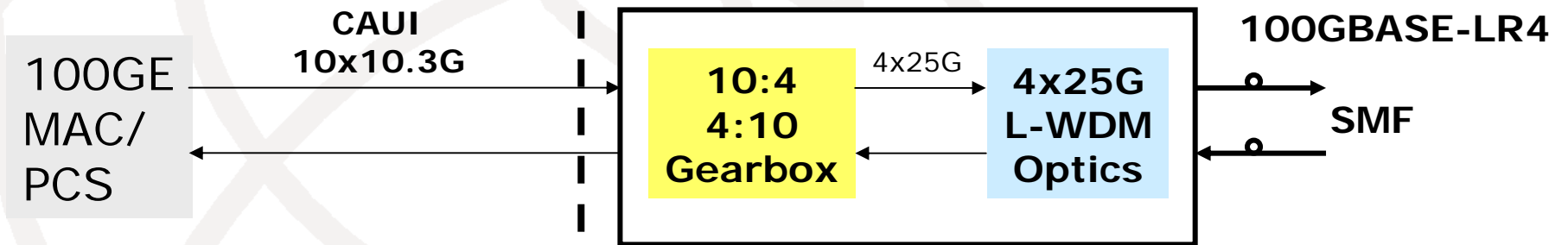
Source: IEEE 802.3 HSSG\_Tutorial\_1107, Nov. 2007

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# 100GE LAN Interface 1<sup>st</sup> Gen

*Host* ← *Elec I/F* → *Optical Transceiver Module*

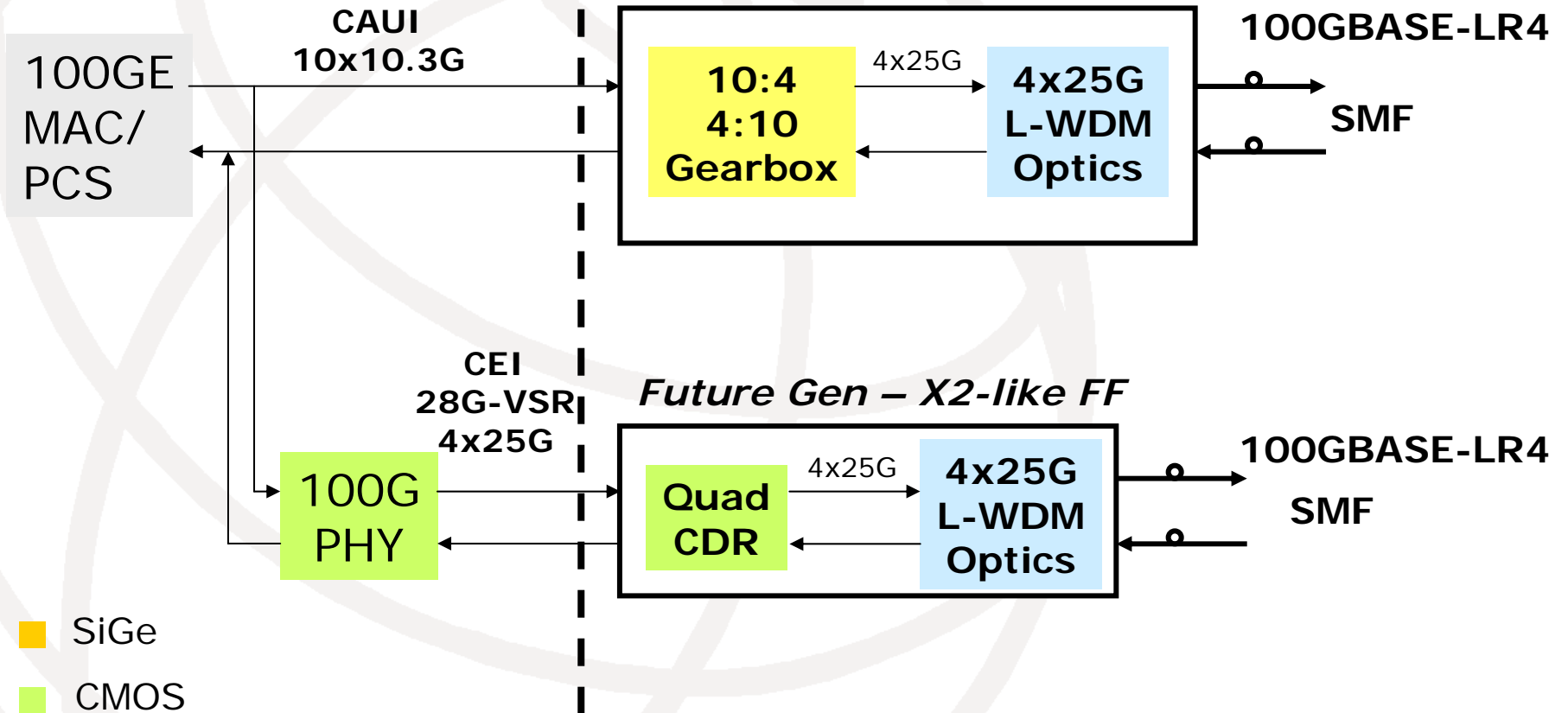
*1<sup>st</sup> Gen - CFP*



■ SiGe

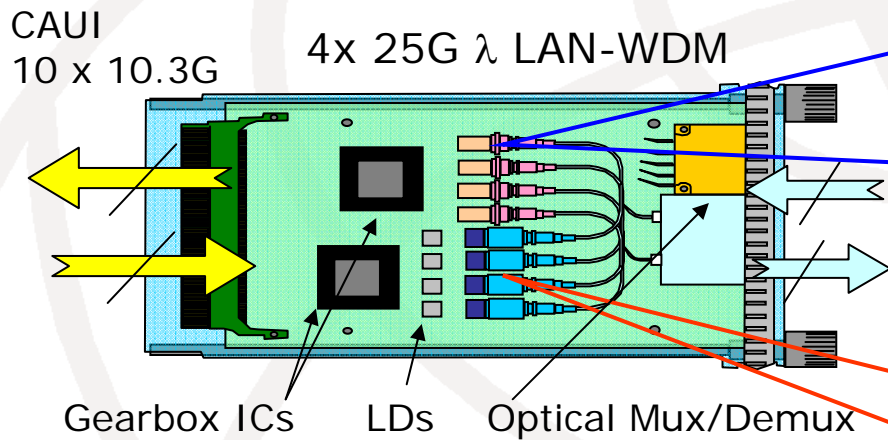
# 100GE LAN Interface Future Gen

*Host* ← *Elec I/F* → *Optical Transceiver Module*



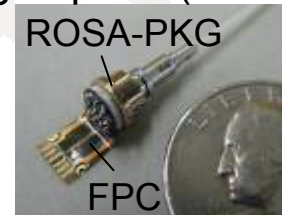
# 100GBASE-LR4 Optical Transceiver

## 1<sup>st</sup> Generation Technology & Architecture

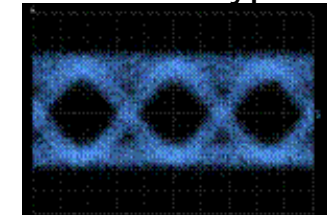


### ROSA: TIA/PIN PD/Package

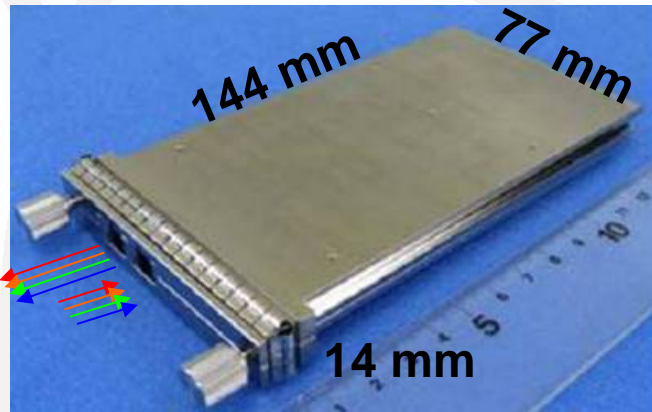
- High-speed/Reliable PIN photo diode
- High-speed (24GHz) FPC/CAN-type PKG



ROSA PKG



25G received waveform  
[-12dBm(OMA)]



CFP MSA

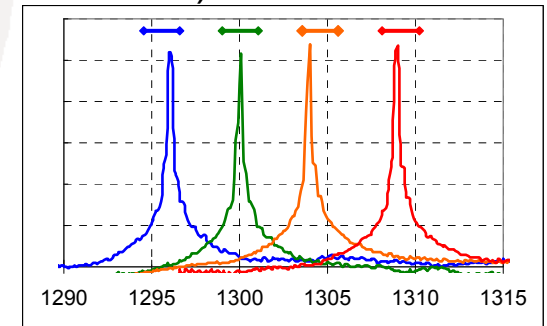
### TOSA: semi-cooled EA-DFB

- High output power (OMA=6.3dBm) LAN-WDM grid
- Wide bandwidth ( $f_{3dB} > 30\text{GHz}$ ) (800GHz pitch)



25.8Gb/s

Optical waveform@60°C



# 100GBASE-LR4 Optical Transceiver

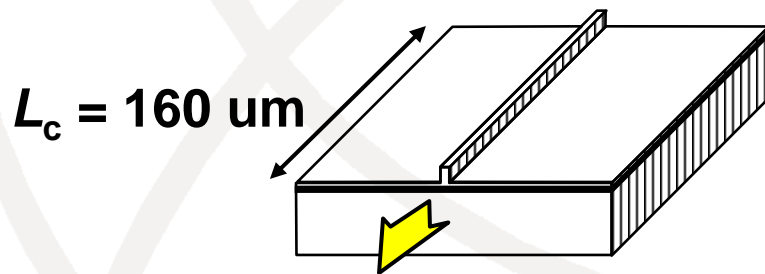
## ■ Future Gen Technology

- ➔ New technology is required for reducing transceiver power-consumption, form factor and cost.

Examination item	Technological opportunity	Technology Approach
Optical devices	Low loss/ Low power consumption	Monolithic Lens integrated: LISEL, LIPD
		Short cavity laser
Analogue circuits	Low power consumption	25 Gb/s SiGe/CMOS IC
Digital circuits		Quad CDR IC
Optical module	Compact/high-density packaging	SIP (Optical MUX/DEMUX and TOSA/ROSAs in one Package)

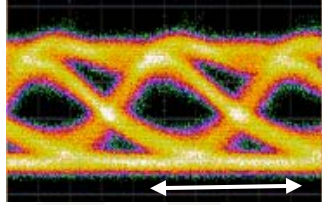
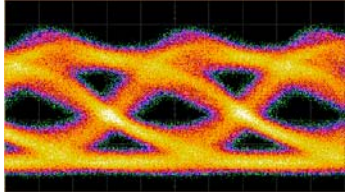
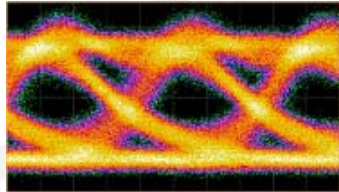
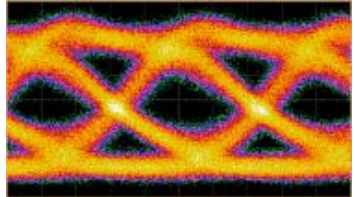


- Ridge Waveguide DFB-type InGaAlAs-MQW
- $\lambda = 1300 \text{ nm}$
- Coating front: AR, rear: HR
- Cavity Length:  $L_c = 160 \text{ }\mu\text{m}$



Shortening  $L_c$  provides:

- High bit rate operation
- Lower threshold current
- Saturation power decreasing
- Increased slope efficiency

$T_{LD}$	25°C	95°C
$I_b$	36 mA	65 mA
ER	9.0 dB	7.0 dB
$V_{pp}$	2.0 V	2.0 V
BTB	 40ps	
10-km SMF		

Ref: T. Fukamachi et al., ECOC, paper 8.2.5 (2009).



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# Lens-Integrated

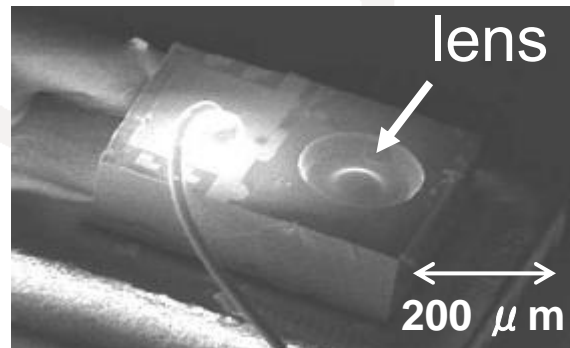
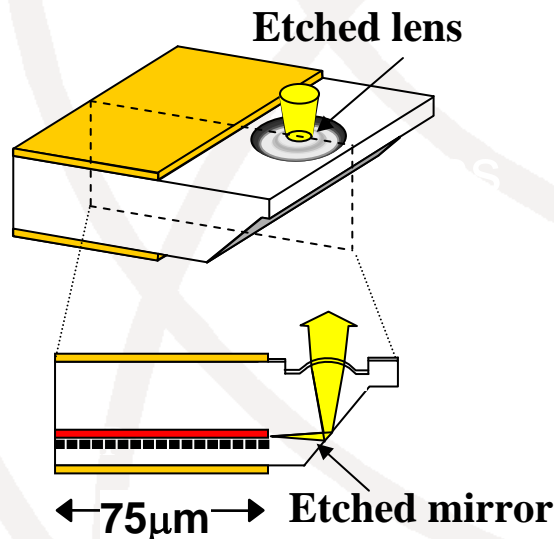
# Surface Emitting Laser (LISEL)



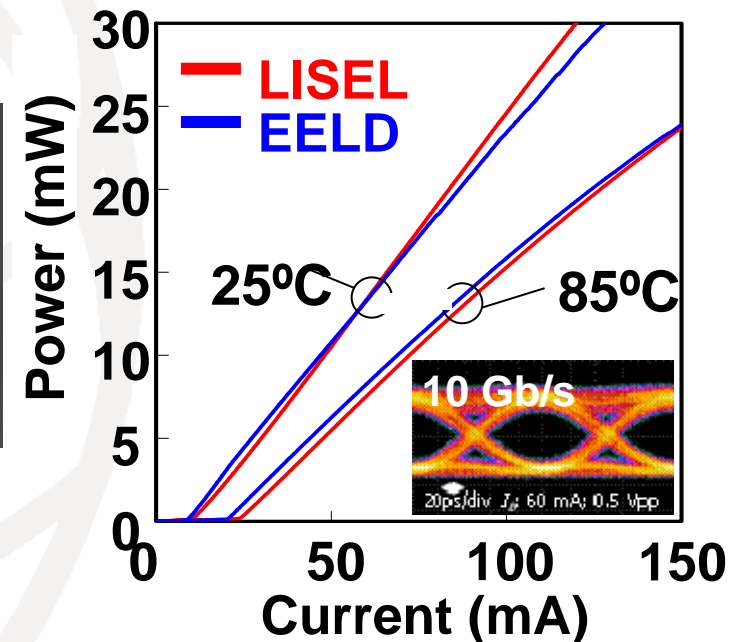
- Assembly friendly, high-speed 1.3- $\mu\text{m}$  surface emitting laser
- Monolithic integration of aspheric InP lens
- High output power exceeding 20mW at 85°C
- May be extended to WDM array device

Schematic of SC-LISEL\*

SEM image of LISEL\*



I-L curves



\*LISEL : Lens-Integrated Surface-Emitting Laser

\*\*EELD : Edge Emitting Laser Diode

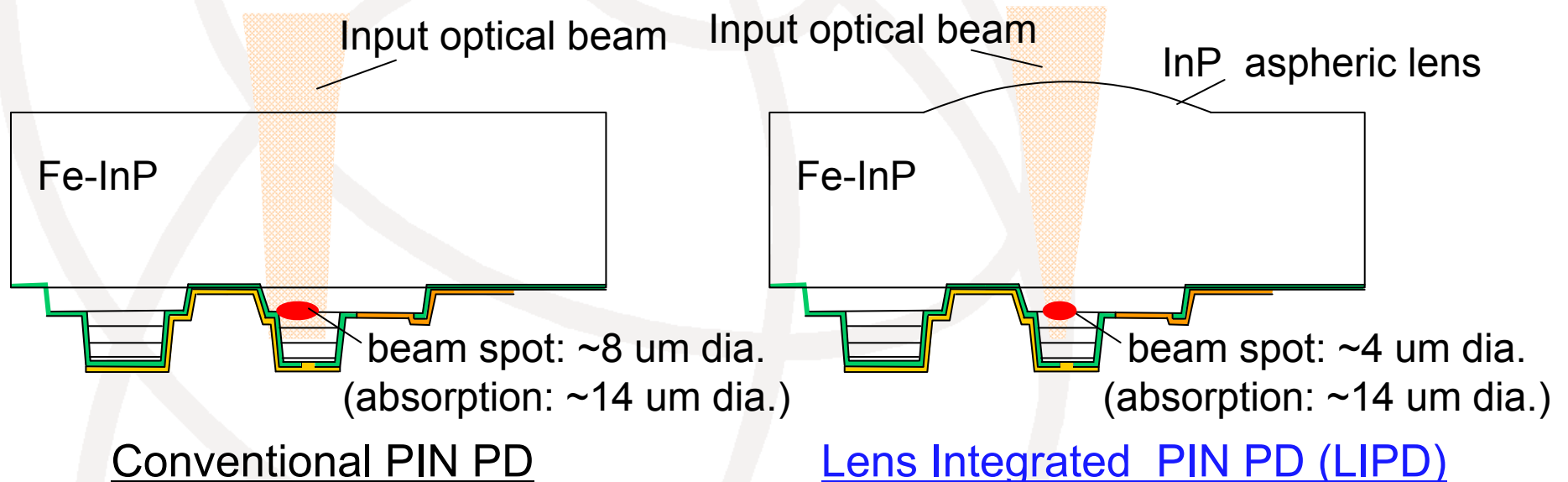
Ref. K. Adachi et al., OFC, paper JthA31 (2009).



# IEEE Lens Integrated PIN PD



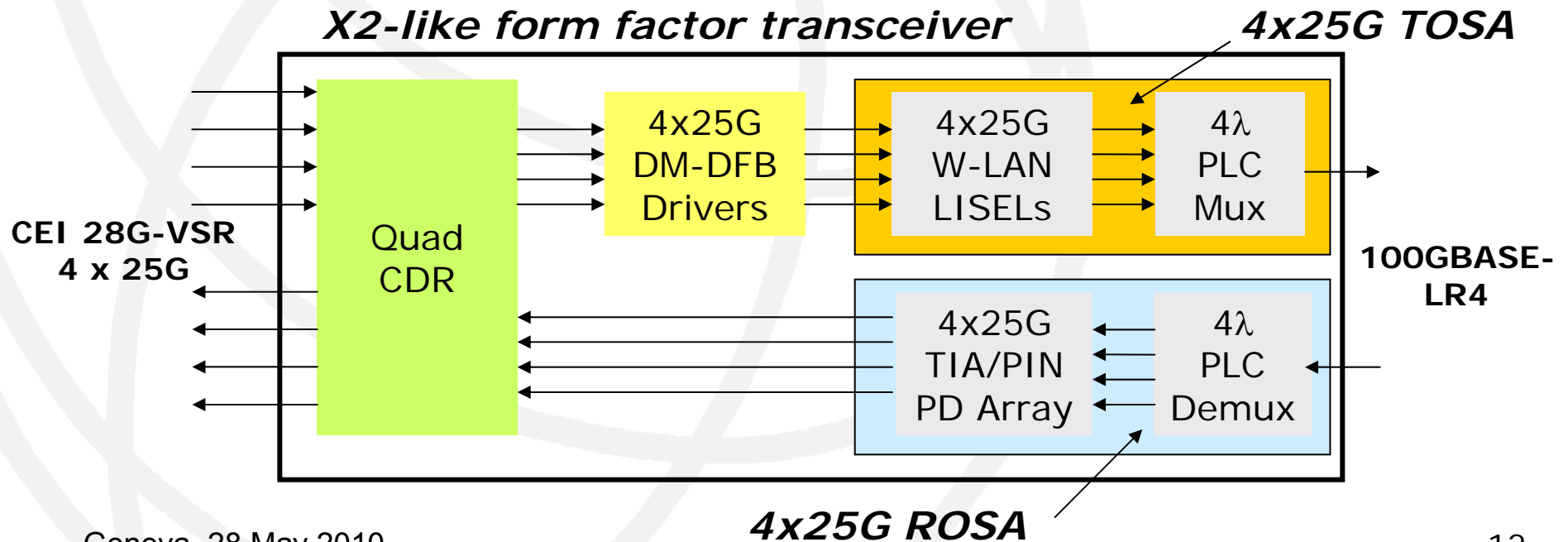
- High optical coupling efficiency and wide tolerance with high speed PD
  - ⇒ Small beam spot:  $\sim 4\mu\text{m}$  dia.  $<$   $\sim 14\mu\text{m}$  dia. (absorption layer)



Ref. Y. Lee et al., OECC, paper ThC4 (2009).

# Future Gen 100GBASE-LR4 Optical Transceiver

- 4ch L-WDM 25G DM-LISELs, lens integrated PIN-PD integrated with PLC mux, demux:
  - Compact 100GE-LR4 TOSA/ROSA devices & transceiver
  - Low power consumption: DM-DFB array w/drivers (4.4W) + TIA/PIN-PD array (0.8W) + quad CDR (2.0W) + DC/DC (0.5) < 8W





# Future Ethernet Optical Client Interface



## ■ Drivers:

- Core Networking bandwidth demand scaling:
  - Core Transport Rate >> 100G; 1TB in 2015??
  - Ethernet Client Interface rates: 4x – 10x in 2015

## ■ Constraints:

- Cost
- Power Consumption
- Module Form Factor

# Future Ethernet Optical Client Interface

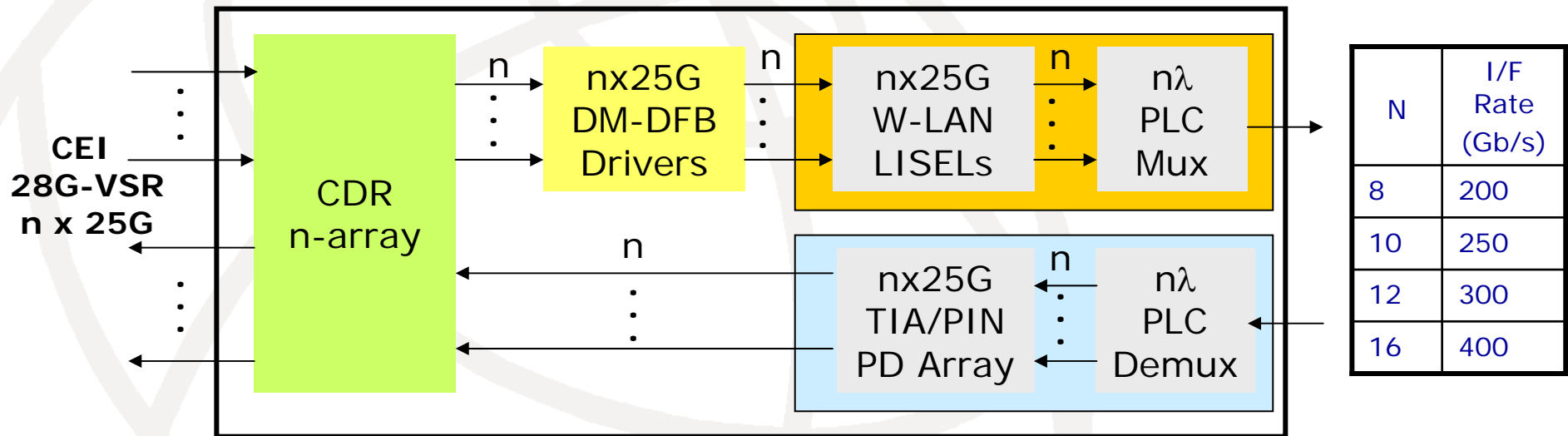


## ■ Design Approaches

- Increase optics speed
- Leverage line-side multi-level modulation, coherent detection technologies to increase spectral efficiency
- Scale LR4 optical parallel architecture
- Scale LR4 optical parallel architecture + increase optics speed
- Others?

# Future Ethernet Optical Client Interface

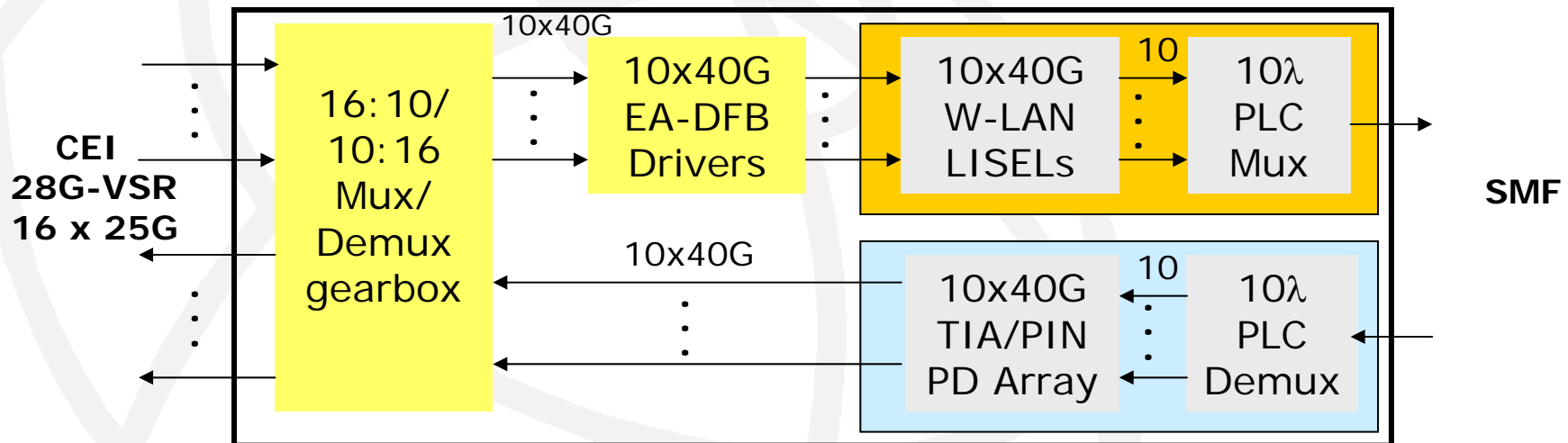
## ■ Scaled LR4 Parallel Architecture: nx25GBASE-LRn



	<i>Pro</i>	<i>Con</i>
<b><i>Pc</i></b>		May be too high for: 4x (8W for 4ch 100BASE-LR4) = 32W
<b><i>FF</i></b>	Potentially CFP-like w/ improved connector	
<b><i>Cost</i></b>	Leverages new gen 100GE-LR4 25G optics, elec devices & integration, packaging processes	16λ L-WDM grid spans ~70nm, challenging for DFB mfg, (monolithic arrays ruled out), leads to high yield loss, higher TOSA cost

# Future Ethernet Optical Client Interface

- Scaled LR4 Parallel Architecture with optics speed increase: 10x40GBASE-LR10

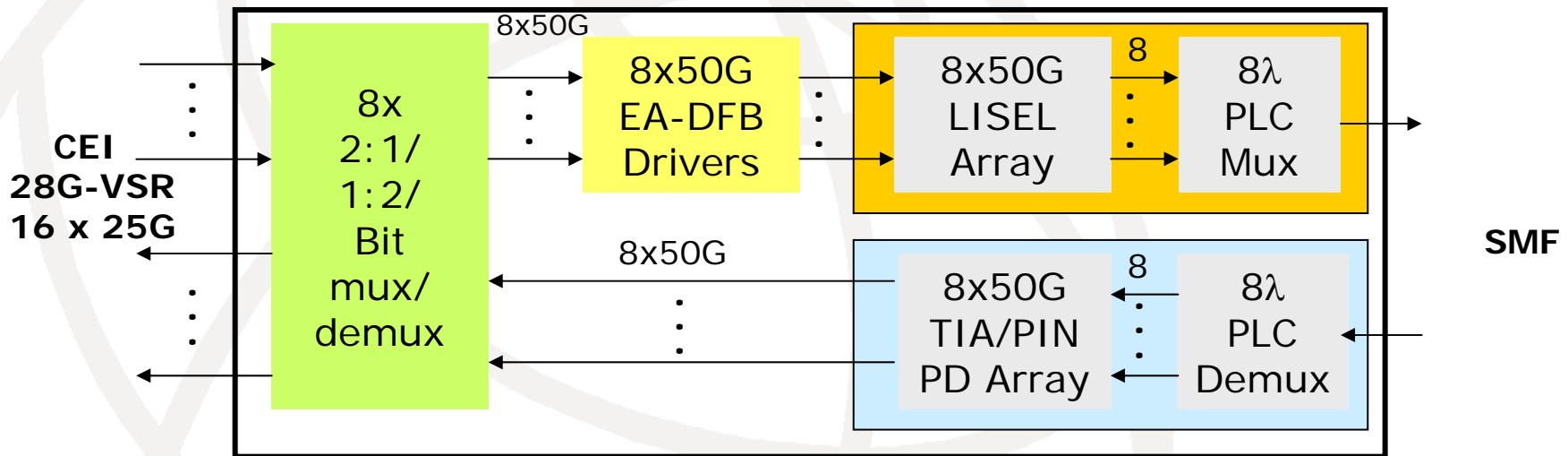


	<i>Pro</i>	<i>Con</i>
<b>Pc</b>		Gearbox IC is >>10Ws; expect module >> 32W
<b>FF</b>		Requires large volume for heat-sinking; probably not pluggable in 1 <sup>st</sup> gen
<b>Cost</b>	Leverages 40G optics, electrical devices & 100G-LR4 integration, packaging processes	10λ L-WDM grid spans ~45nm, still challenging for DFB mfg, (monolithic arrays ruled out), leads to high yield loss, higher TOSA cost; higher cost new gen gearbox IC process needed to reduce power



# Future Ethernet Optical Client Interface

- Scaled LR4 Parallel Architecture with optics speed increase: 8x50GBASE-LR8



	<i>Pro</i>	<i>Con</i>
<b>Pc</b>	Bit mux IC much easier to implement with much lower power consumption cf gearbox	
<b>FF</b>	Potentially CFP-like w/ improved connector	
<b>Cost</b>	8λ L-WDM or possibly CWDM laser yield much easier to manage, monolithic array may be in reach for lower cost	50G EA-DFB not yet proven technology

- Ethernet optical client interfaces have kept pace with core network demand by leveraging optical line side technology
- We are at a cross-over point now at 100GE with given core networking bw need projected to be 4x – 10x by 2015
- Integrated parallel optics technologies being developed for next gen 40G/100GBASE-LR4 will be leveraged for beyond 100GE client interfaces
- A combination of increased optics speeds (25G -> 50G) with 2x 100G-LR4 parallel optics may be the best approach to achieve > 100GE



**Thank You!**